

EUROPEAN PATENT OFFICE

Patent Abstracts of Japan

PUBLICATION NUMBER : 03084521
PUBLICATION DATE : 10-04-91

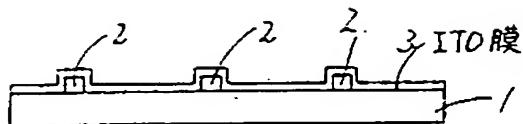
APPLICATION DATE : 29-08-89
APPLICATION NUMBER : 01220385

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INT.CL. : G02F 1/1343 G02F 1/1333

TITLE : PATTERING METHOD



ABSTRACT : PURPOSE: To form a fine pattern by printing by forming an SiO_2 film and an ITO film uniformly over the entire surface of a board after printing and removing resist ink.

CONSTITUTION: A positive printing plate for a no-electrode circuit part is prepared. Then resist ink 2 is printed in specific pattern on the board 1 by using the printing plate, SiO_2 is filmed uniformly over the entire surface of the board after the printing, and the ITO film 3 is formed thereupon; and the resist ink 2 is removed and the ITO film 3 at an electrode gap part is removed at the same time. Consequently, a line which is thinner than that by printing can be formed except a white void part and a gap of 20 - 30 μm can be formed.

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